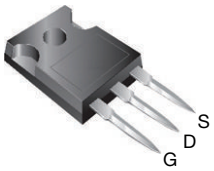
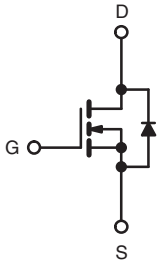
S Series Power MOSFET

PRODUCT SUMMARY		
V_{DS} (V) at T_J max.	650	
$R_{DS(on)}$ max. at 25 °C (Ω)	V_{GS} = 10 V	0.07
Q_g max. (nC)	216	
Q_{gs} (nC)	39	
Q_{gd} (nC)	57	
Configuration	Single	

TO-247AC





N-Channel MOSFET

FEATURES

- Generation one
- Low figure-of-merit R_{on} x Q_g
- 100 % avalanche tested
- Ultra low gate charge
- Ultra low R_{on}
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT

APPLICATIONS

- PFC power supply stages
- Hard switching topologies
- Solar inverters
- UPS
- Motor control
- Server telecom

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	SiHG47N60S-E3

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	600	V
Gate-Source Voltage			V_{GS}	± 30	
Continuous Drain Current (T_J = 150 °C)	V_{GS} at 10 V	T_C = 25 °C	I_D	47	A
		T_C = 100 °C		30	
Pulsed Drain Current [a]			I_{DM}	140	
Linear Derating Factor				3.3	W/°C
Avalanche Energy (repetitive)			E_{AR}	0.42	mJ
Single Pulse Avalanche Energy [b]			E_{AS}	1800	
Maximum Power Dissipation			P_D	417	W
Operating Junction and Storage Temperature Range			T_J, T_{stg}	-55 to +150	°C
Drain-Source Voltage Slope	T_J = 125 °C		dV/dt	37	V/ns
Reverse Diode dV/dt [d]				8.5	
Soldering Recommendations (Peak Temperature) [c]	for 10 s			300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.
b. V_{DD} = 50 V, starting T_J = 25 °C, L = 73.5 mH, R_g = 25 Ω, I_{AS} = 7 A.
c. 1.6 mm from case.
d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

THERMAL RESISTANCE RATINGS				
PARAMETER	**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Maximum Junction-to-Ambient	R_{thJA}	-	40	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.3	

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA	600	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, I_D = 1 mA	-	0.7	-	V/°C
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	2	-	4	V
Gate-Source Leakage	I_{GSS}	V_{GS} = ± 20 V	-	-	± 100	nA
		V_{GS} = ± 30 V	-	-	± 1	µA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 600 V, V_{GS} = 0 V	-	-	1	µA
		V_{DS} = 600 V, V_{GS} = 0 V, T_J = 150 °C	-	-	10	
Drain-Source On-State Resistance	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 24 A	-	0.057	0.07	Ω
Forward Transconductance [a]	g_{fs}	V_{DS} = 8 V, I_D = 3 A	-	7.5	-	S
Dynamic						
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 100 V, f = 1 MHz	-	6630	-	pF
Output Capacitance	C_{oss}		-	220	-	
Reverse Transfer Capacitance	C_{rss}		-	7	-	
Total Gate Charge	Q_g	V_{GS} = 10 V, I_D = 20 A, V_{DS} = 400 V	-	180	216	nC
Gate-Source Charge	Q_{gs}		-	39	-	
Gate-Drain Charge	Q_{gd}		-	57	-	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 380 V, I_D = 47 A, R_g = 4.4 Ω, V_{GS} = 13 V	-	30	60	ns
Rise Time	t_r		-	12	25	
Turn-Off Delay Time	$t_{d(off)}$		-	115	175	
Fall Time	t_f		-	9	20	
Gate Input Resistance	R_g	f = 1 MHz, open drain	-	0.62	-	Ω
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode 	-	-	47	A
Pulsed Diode Forward Current	I_{SM}		-	-	140	
Body Diode Voltage	V_{SD}	T_J = 25 °C, I_S = 47 A, V_{GS} = 0 V	-	-	1.2	V
Body Diode Reverse Recovery Time	t_{rr}	T_J = 25 °C, I_F = I_S, dI/dt = 100 A/µs, V_R = 25 V	-	750	1125	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	18	36	µC
Body Diode Reverse Recovery Current	I_{RRM}		-	39	80	A

Note

a. $C_{oss\ eff.}$ (TR) is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

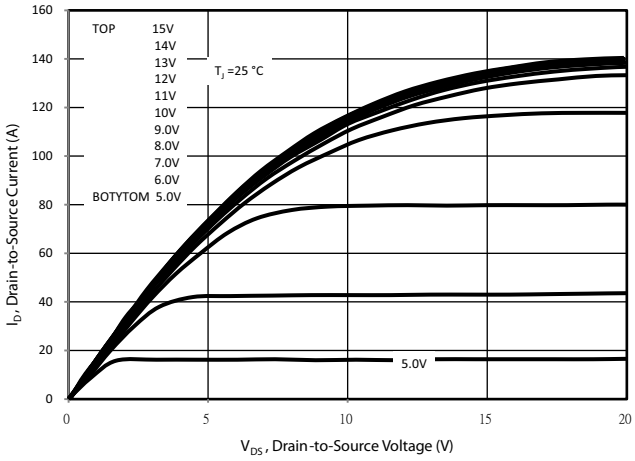


Fig. 1 - Typical Output Characteristics (TO-247)

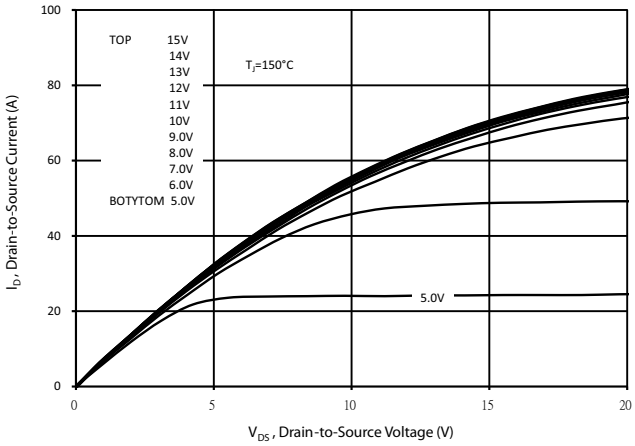


Fig. 2 - Typical Output Characteristics (TO-247)

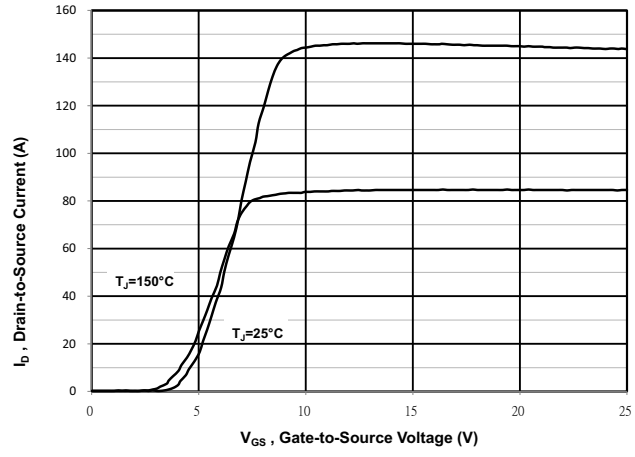


Fig. 3 - Typical Transfer Characteristics

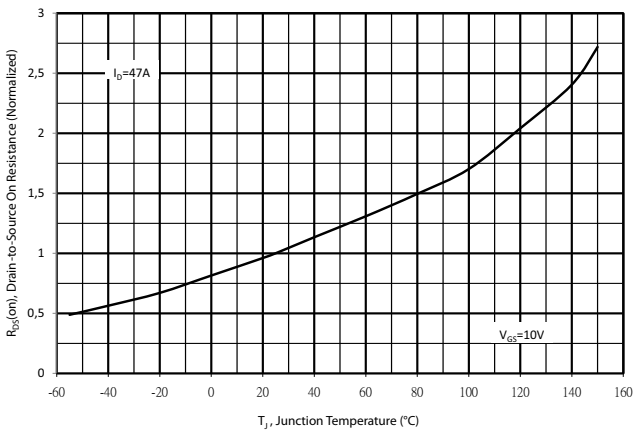


Fig. 4 - Normalized On-Resistance vs. Temperature

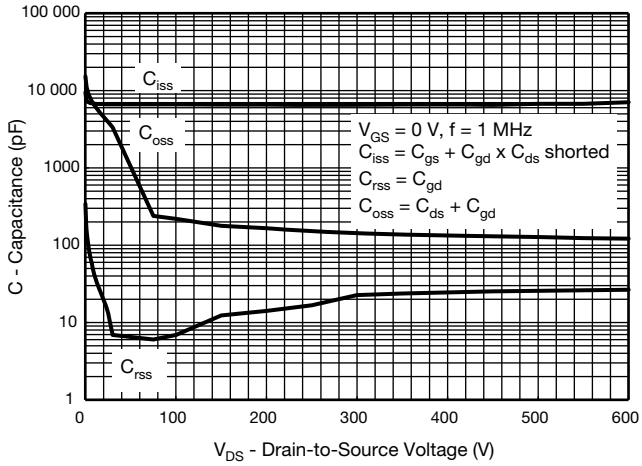


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

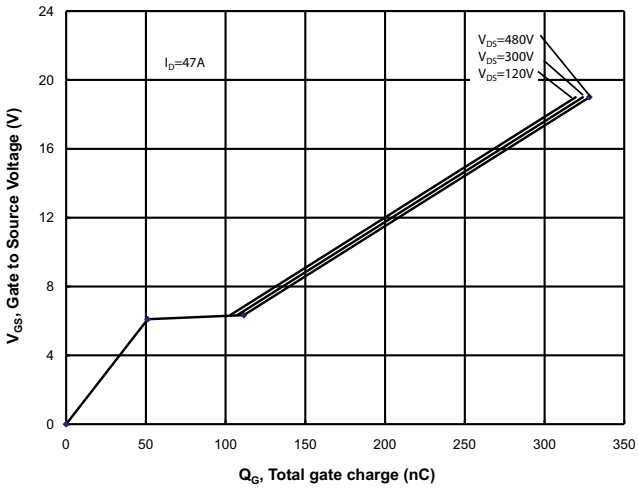


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

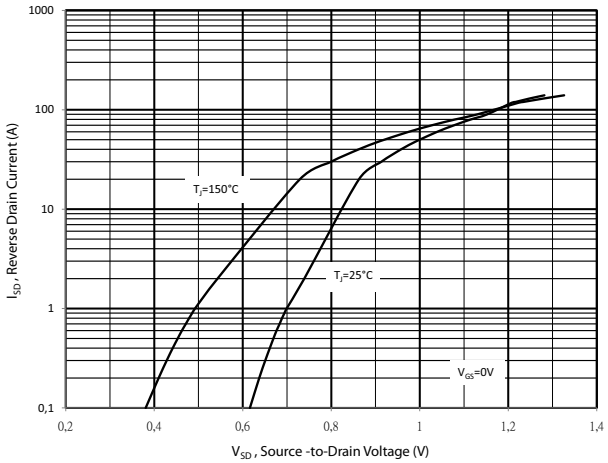


Fig. 7 - Typical Source-Drain Diode Forward Voltage

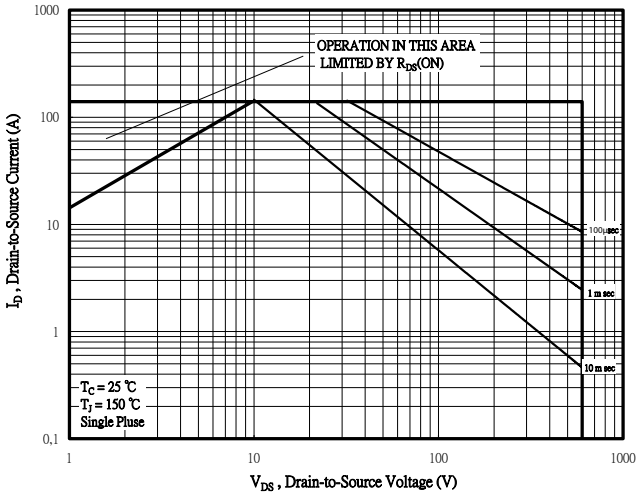


Fig. 8 - Maximum Safe Operating Area

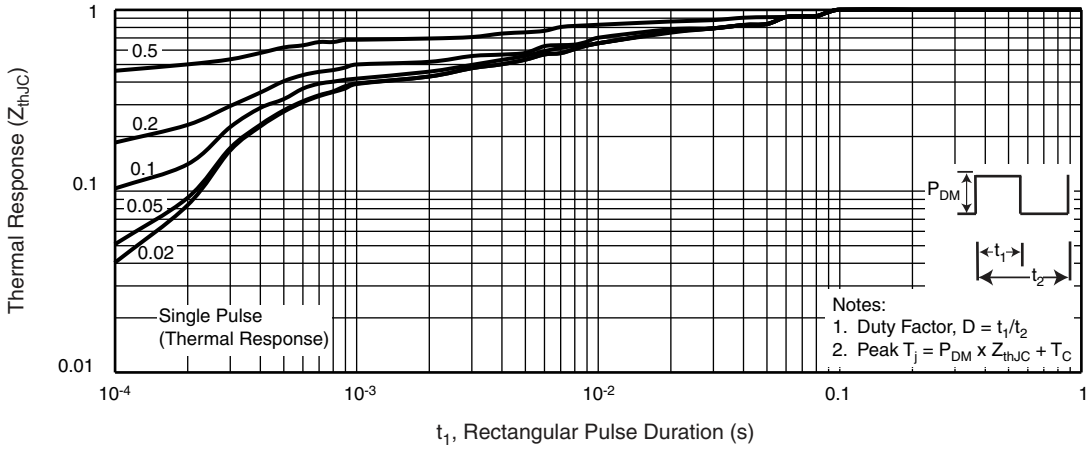


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Case (TO-247AC)

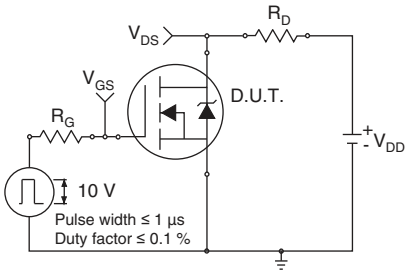


Fig. 10 - Switching Time Test Circuit

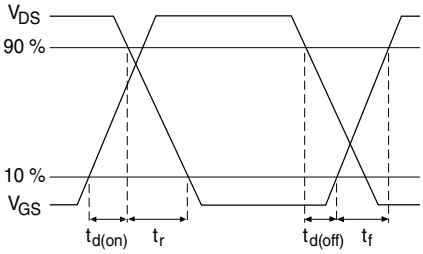


Fig. 11 - Switching Time Waveforms

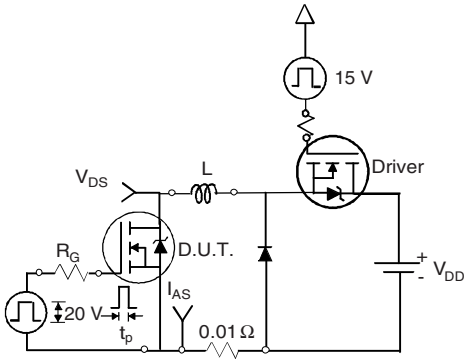


Fig. 12 - Unclamped Inductive Test Circuit

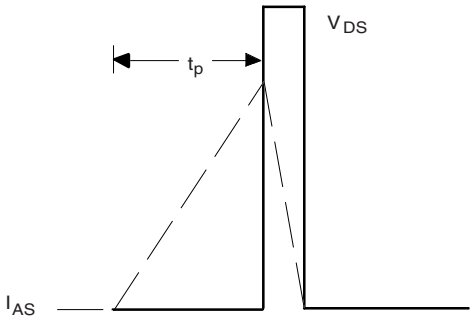


Fig. 13 - Unclamped Inductive Waveforms

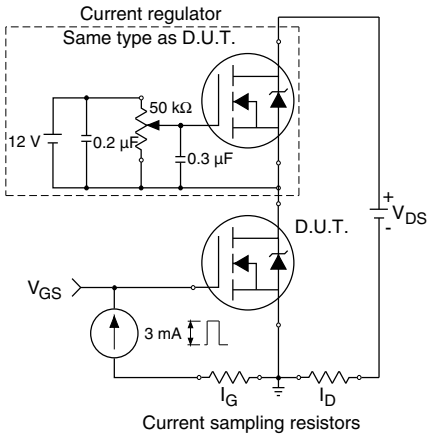


Fig. 15 - Gate Charge Test Circuit

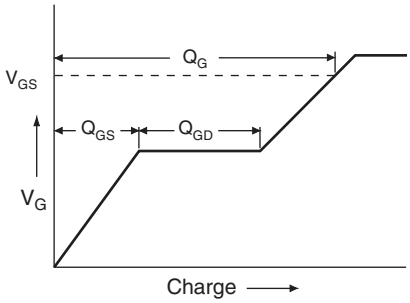
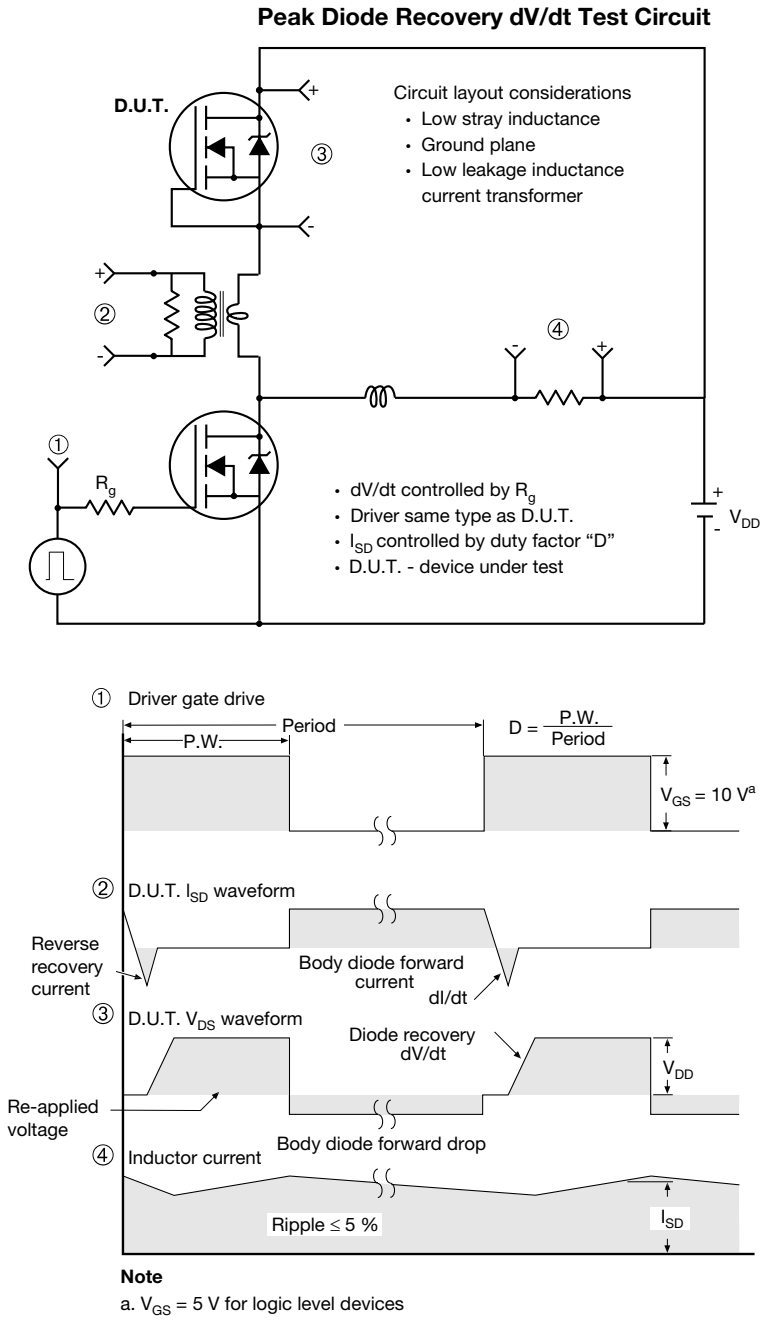


Fig. 14 - Basic Gate Charge Waveform



Note

a. V_{GS} = 5 V for logic level devices

Fig. 16 - For N-Channel

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